

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	(electrical with thermal)adj conductive adj paste	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 11:53
L2	143	ceramic adj paste with conductive	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 11:54
L3	98	ceramic adj paste with conductive and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 11:55
L4	319	(conductive or metal) near4 ceramic adj paste and chip and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 11:57
L5	107	(conductive or metal) near2 ceramic adj paste and chip and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 12:01
L6	30	(conductive or metal) near2 ceramic adj paste and chip and module and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 12:01
L7	35	(conductive or metal) near2 ceramic adj paste and module and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 12:03
L8	1	(conductive or metal) near2 ceramic adj paste same shield\$3 and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 12:04
L13	245	alumina with conductive adj paste	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 12:14
L14	32	alumina with conductive adj paste and module and chip	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 12:14
L15	348	(alumina or aluminum adj oxide or ceramic) with conductive adj paste and module and chip	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 12:16
L16	235	(alumina or aluminum adj oxide or ceramic) with conductive adj paste and module and chip and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 12:19

L17	34	(alumina or aluminum adj oxide or ceramic) near3 conductive adj paste and module and chip and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 12:19
L18	52	(alumina or aluminum adj oxide or ceramic) near4 conductive adj paste and module and chip and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 12:21
L19	18	(alumina or aluminum adj oxide or ceramic) near1 conductive adj paste and via and chip and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 12:25
L20	4	(alumina or aluminum adj oxide or ceramic) near1 conductive adj paste same (via or hole) and chip and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 12:26
L27	0	jp0418469	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/09 13:13
L28	448059	pct jp0418469	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/09 13:13
L29	0	pct jp0418469	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/09 13:13
L30	6	"461855".ap.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/09 13:17
L31	0	"203309213"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/09 13:20

L32	2	"2003309213"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/09 13:20
L33	3	"2000223647"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/09 13:20
L34	3	"2003258192"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/09 13:22
L35	2064	terminals shield\$3 module	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	SAME	ON	2009/03/09 13:22
L36	73	terminals shield\$3 module epoxy	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	SAME	ON	2009/03/09 13:23
L37	3732	etching same wir\$3 same (laser or dicing)	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 13:57
L38	2148	etching same wir\$3 same (laser or dicing)and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 13:58
L39	574	etching wir\$3 (laser or dicing)and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	WITH	ON	2009/03/09 13:59
L40	1256	pattern\$3 wir\$3 (laser or dicing)and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	WITH	ON	2009/03/09 14:01
L41	886	pattern\$3 near4 wir\$3 (laser or dicing)and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	WITH	ON	2009/03/09 14:02
L42	126	ceramic conductive paste	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 14:46
L43	100	ceramic conductive paste and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 14:46
L44	177	ceramic near2 conductive adj paste and @ad<"20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 14:48

L45	64	ceramic near1 conductive adj paste and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 14:50
L46	199	conductive ceramic (filler or paste)	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 14:56
L47	7	(alumina or aluminum adj oxide or ceramic) near conductive adj paste and module and chip	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 15:04
L48	7	(alumina or aluminum adj oxide or ceramic)adj conductive adj paste same via	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 15:05
L49	7	(alumina or aluminum adj oxide or ceramic or inorganic)adj conductive adj paste same via	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 15:06
L50	83	(ceramic or inorganic) adj (powder or filler or particle)near4 (conductive) adj (resin or paste)	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:22
L51	0	reistive adj paste and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:32
L52	363	resistive adj paste and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:32
L53	46	resistive adj paste and module and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:33
L54	3	conductive resistive adj paste and module and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:35
L55	9	conductive resistive adj paste and via and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:35
L56	31	conductive ceramic adj paste and via and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:38
L57	0	conductive ceramic adj paste @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:38
L58	64	conductive ceramic adj paste and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:38
L59	624	conductive near5 ceramic adj paste and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:39

L60	0	conductive near5 ceramic adj paste and (walls or shield\$3 or via or hole) @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:40
L61	0	conductive near5 ceramic adj resin and (walls or shield\$3 or via or hole) @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:40
L62	0	ceramic powder conductive ear4 paste	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:51
L63	30	ceramic powder conductive near4 paste	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:51
L64	0	tungsten carbide near4 paste (via or hole)	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:52
L65	38	tungsten carbide near4 paste same (via or hole)	US-PGPUB; USPAT; USOCR; FPRS	NEAR	ON	2009/03/09 15:53
L66	2438	438/125,126.ccls.	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 16:05
L67	1595	438/125,126.ccls. and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 16:05
L68	421	module and 438/125,126. ccls. and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 16:06
L69	30	module and 257/699.ccls. and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 16:21
L70	548	module and 257/678.ccls. and @ad< "20040330"	US-PGPUB; USPAT; USOCR; FPRS	OR	ON	2009/03/09 16:24

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